

Amendments to the Claims:**1. (CURRENTLY AMENDED) A crosstalk and EME (electromagnetic emission)**

minimizing trace suspension assembly structure comprising:

multiple write lines which are crossed between said preamplifier connection point and said slider contact pads;

multiple read lines driven by pre-amplifier circuits;

slider contact pads, which connect said write lines to said trace suspension assembly;

slider contact pads, which connect said read lines to said trace suspension assembly; and

multiple write line driven by preamplifierlifierpreamplifier circuits,
wherein said multiple write lines which are crossed between said preamplifier connection point and said slider contact pads are used to cancel out time-delayed (transmission line effects) parts of said crosstalk and said EME.

2. (CURRENTLY AMENDED) The crosstalk and EME minimizing structure of claim 1

wherein said crossing point of said write lines between said preamplifier connection point and said slider contact pads is placed halfway between said preamplifier connection point and said slider contact pads.

3. (CURRENTLY AMENDED) The crosstalk and EME minimizing structure of claim 1 wherein saida crossing point of said write line is made by the addition of a second metallization layer onto said trace suspension assembly.
4. (ORIGINAL) The crosstalk and EME minimizing structure of claim 1 wherein multiple crossing points of said write lines are used to further cancel out time-delayed (transmission line effects) parts of said crosstalk and EME.
5. (ORIGINAL) The crosstalk and EME minimizing structure of claim 1 wherein said write lines have parasitic capacitance between the write lines and the read lines.
6. (ORIGINAL) The crosstalk and EME minimizing structure of claim 5 wherein said parasitic capacitances between the write lines and read lines are used to cancel crosstalk noise between said write lines and said read lines.

7-18. Canceled

19. (CURRENTLY AMENDED) A method of minimizing crosstalk and EME (electromagnetic emission) in a trace suspension assembly structure comprising the steps of:
 - providing multiple write lines which are crossed between saida preamplifier connection point and said-slider contact pads;
 - providing multiple read lines driven by pre-amplifier circuits;

providing slider contact pads, which connect said write lines to said trace suspension assembly;

providing slider contact pads, which connect said read lines to said trace suspension assembly; and

providing multiple write line driven by preamplifierlifierpreamplifier circuits,
wherein said multiple write lines which are crossed between said
preamplifier connection point and said slider contact pads are used to cancel out
time-delayed (transmission line effects) parts of said crosstalk and said EME.

20. (CURRENTLY AMENDED) The method of minimizing crosstalk and EME of claim 19 wherein saida crossing point of said write lines between said preamplifier connection point and said slider contact pads is placed halfway between said preamplifier connection point and said slider contact pads.

21. (CURRENTLY AMENDED) The method of minimizing crosstalk and EME of claim 19 wherein saida crossing point of said write line is made by the addition of a second metallization layer onto said trace suspension assembly.

22. (ORIGINAL) The method of minimizing crosstalk and EME of claim 19 wherein multiple crossing points of said write lines are used to further cancel out time-delayed (transmission line effects) parts of said crosstalk and EME.

23. (ORIGINAL) The method of minimizing crosstalk and EME of claim 19 wherein said write lines have parasitic capacitance between the write lines and the read lines.

24. (ORIGINAL) The method of minimizing crosstalk EME of claim 23 wherein said parasitic capacitances between the write lines and read lines are used to cancel crosstalk noise between said write lines and said read lines.

25-36. Canceled